IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Kazuaki YAZAWA

Filed: Filed Concurrently Herewith

Title of Invention: HEAT DISSIPATING STRUCTURE FOR AN

ELECTRONIC DEVICE

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EXPRESS MAIL

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INFORMATION DISCLOSURE STATEMENT

Mail Stop Patent Application Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Enclosed are copies of references which were cited in the Japanese Patent Office in connection with the corresponding Japanese patent application. Also enclosed is a copy of Form PTO-1449. Entry of this Information Disclosure Statement and an early examination on the merits are respectfully solicited.

Please charge any additional fees to Deposit Account No. 50-0320.

Respectfully submitted,

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LIST OF REFERENCES CITED BY APPLICANT (Use several sheets if necessary)	APPLICANT Kazuaki YAZAWA			
	FILING DATE Filed Concurrently Herewith	GROUP		

		T	U.S	. PATENT DOCUMENTS					
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE		
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<u>.</u>	AR	Patent Abstracts of Japan 09-212258 dated 08/15/97							
	AS	Allan D. Kraus et al., "DESIGN AND ANALYSIS OF HEAT SINKS", 1995 A Wiley-Interscience Publication, pages 286-291							
	AT	Akash Jain et al., "BUOYANCY-DRIVEN FLOW IN CHANNELS WITH IN-LINE PIN FINS" Proceedings of ASME NHTC'01, 35th National Heat Transfer Conference Anaheim, California, June 10-12, 2001, pages 1-8							
	AU	William K. Coxe III et al., "EXPERIMENTAL MODELING OF THE PASSIVE COOLING LIMIT OF NOTEBOOK COMPUTERS", 2002 Inter Society Conference on Thermal Phenomena, pages 15-21							
EXAMINER				DATE CONSIDERED	DATE CONSIDERED				
* EXAMINED through applica	citation	ial if reference consi	dered, whether and not con-	er or not citation is in conf sidered. Include copy of thi	formance with	h MPEP 609. next commun	Draw line ication to		